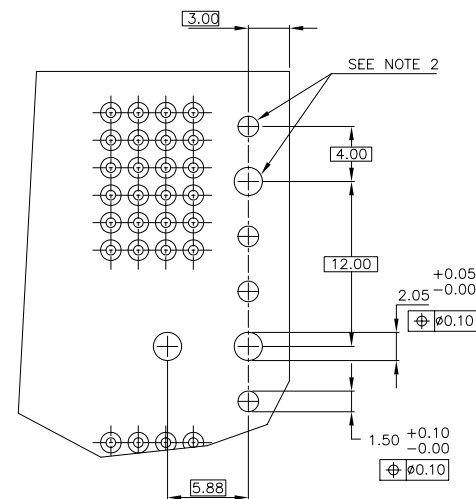
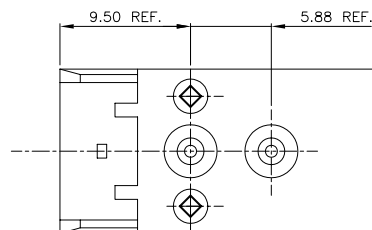
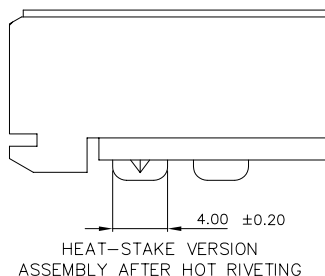
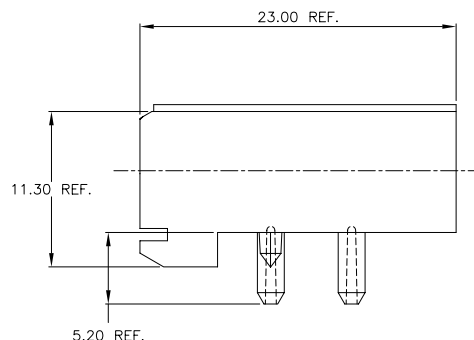
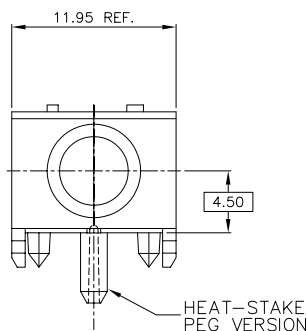


PRODUCT NUMBER	DESCRIPTION
88917-101 & -101LF	HEAT STAKE VERSION

FRONT VIEW



REQUIRED PC BOARD LAYOUT COMPONENT SIDE

NOTE:

- HOUSING MATERIAL: LCP, 30% GLASS FILLED
FLAME RETARDANT PER UL 94V-0.
COLOR: NATURAL
- INDICATED HOLES ARE UNPLATED
- PART NUMBER WITH "LF" SUFFIX AT THE END ARE LEAD FREE OPTION
- THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER
COUNTRY REGULATION AS DESCRIBED IN GS-22-008.
- THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK
TEMPERATURE FOR 15 SECONDS IN A WAVE SOLDER APPLICATION
WITH A 1.5mm MINIMUM THICK CIRCUIT BOARD OR FOR 10-20
SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW
OVEN. SEE APPLICATION NOTES/PROCEDURES IF THEY ARE AVAILABLE.

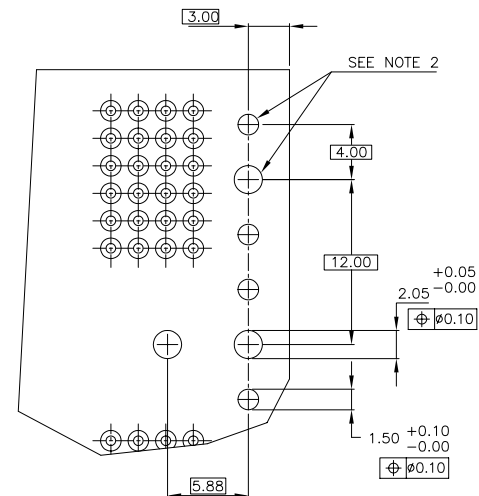
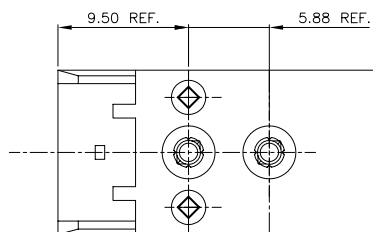
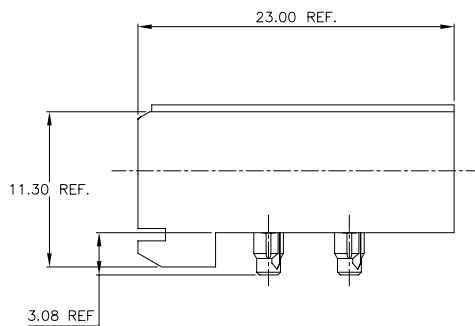
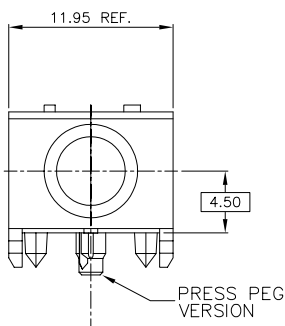
mat'l. code				surface		tolerance	projection	product family	
SEE NOTES				ISO 1302		ISO 406 ISO 1101		METRAL ACC.	
ltr	ecn	no	dr	date	tolerances unless otherwise specified			title	
F	C80040	MDF		7/23/98	angles	linear	xx ±.01/.3	mm	
G	H80473	MDF		7/23/98			xxx ±.005/.13		
H	V02701	JWS		10/19/00	0°±2'		xxxx ±.0020/.050	scale 1:1	
J	V11668	LSS		6/13/01	dr	S. STONER	9/30/93	FCI	
K	V12868	CGD		1/02/02	enrg	R. DOUTRICH	9/30/93		
L	M05-0262	MHT		12/20/05	chr	S. STONER	9/30/93		
M	M06-0286	MNR		7/27/06	appd	S. STONER	9/30/93		
sheet	revision	M	M	M	M	M		type	
index	sheet	1	2	3	4			Product Customer Drawing	

RECEPTACLE GUIDE
MODULE, 4 ROW

dwg no 88917 sheet 1 of 4 size A3

PRODUCT NUMBER	DESCRIPTION
88917-201 & -201LF	PRESS-PEG VERSION

FRONT VIEW



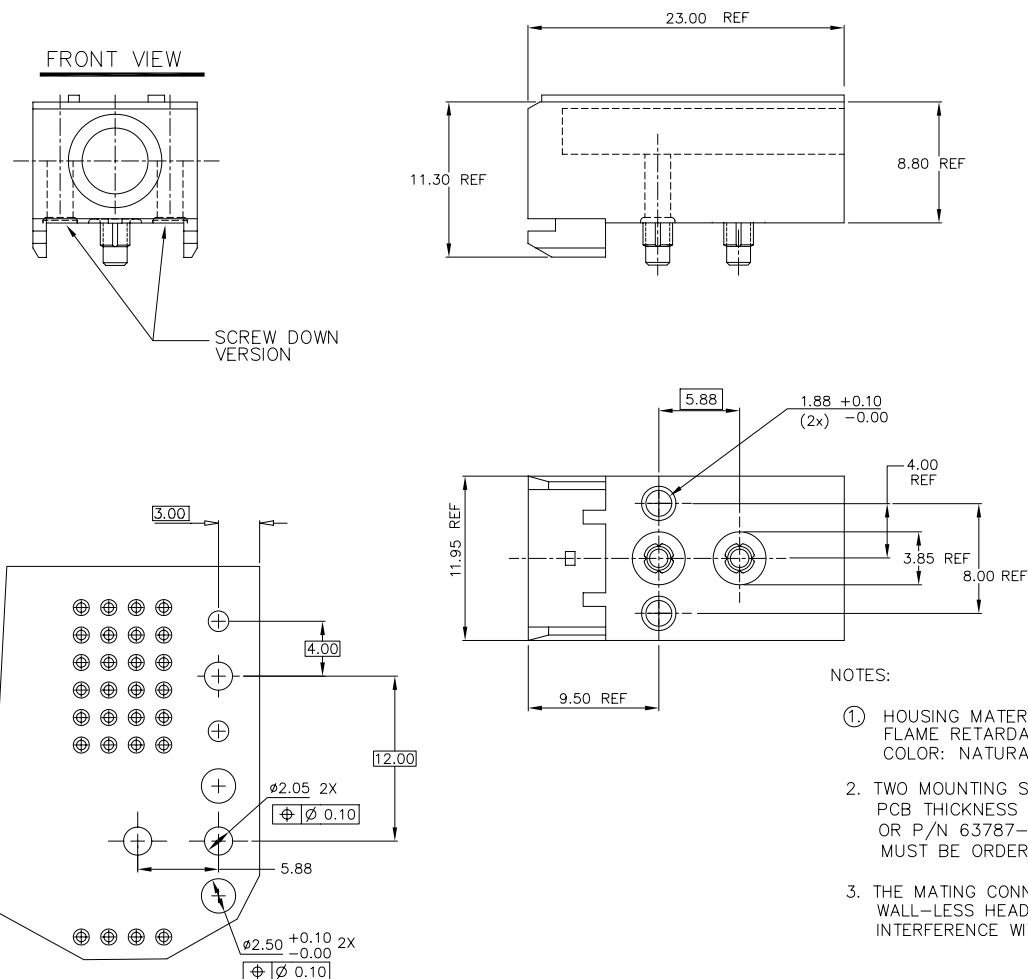
REQUIRED PC BOARD LAYOUT
COMPONENT SIDE

NOTE:

- HOUSING MATERIAL: LCP, 30% GLASS FILLED
FLAME RETARDANT PER UL 94V-0.
COLOR: NATURAL
- INDICATED HOLES ARE UNPLATED
- PART NUMBER WITH "LF" SUFFIX AT THE END ARE LEAD FREE OPTION
- THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER
COUNTRY REGULATION AS DESCRIBED IN GS-22-008.
- THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK
TEMPERATURE FOR 15 SECONDS IN A WAVE SOLDER APPLICATION
WITH A 1.5mm MINIMUM THICK CIRCUIT BOARD OR FOR 10-20
SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW
OVEN. SEE APPLICATION NOTES/PROCEDURES IF THEY ARE AVAILABLE.

mat'l. code SEE NOTES				surface ISO 1302 ✓	tolerance ISO 406 ISO 1101	projection mm	product family METRAL ACC.
ltr	ecn	no	dr	date	tolerances unless otherwise specified		title
M					angles	linear	RECEPTACLE GUIDE MODULE, 4 ROW
					0°±2'	xxx ±.01/.3 xxx ±.005/.13 xxxx ±.0020/.050	scale 1:1
			dr	S. STONER	9/30/93	FCI	dwg no
			enr	R. DOUTRICH	9/30/93		88917
			chr	S. STONER	9/30/93		sheet2 of 4 size
			appd	S. STONER	9/30/93		A3
sheet	revision						type
index	sheet						Product Customer Drawing

PRODUCT #	DESCRIPTION
88917-301 & -301LF	SCREW DOWN VERSION



NOTES:

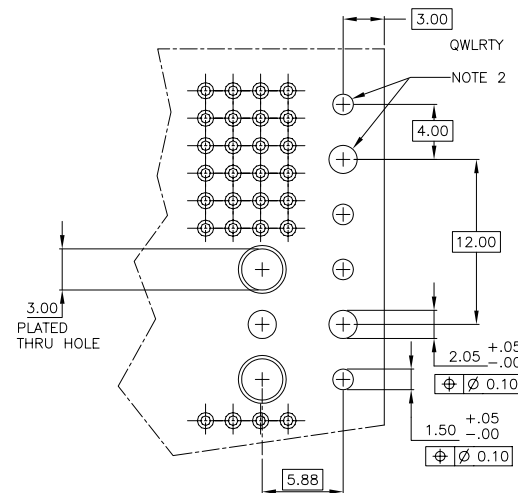
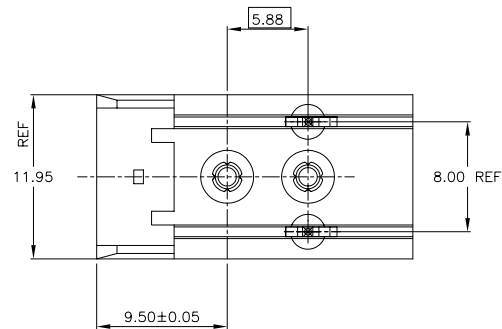
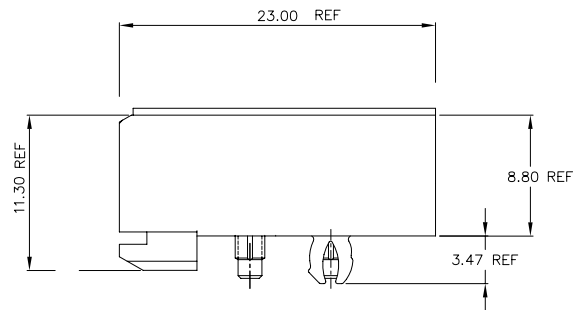
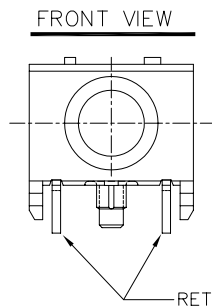
- ① HOUSING MATERIAL: LCP, 30% GLASS FILLED
FLAME RETARDANT PER UL 94V-0.
COLOR: NATURAL
2. TWO MOUNTING SCREWS, P/N 63787-001, FOR MAX
PCB THICKNESS 2.4mm [0.094"].
OR P/N 63787-002 FOR MAX PCB THICKNESS 3.2mm [0.126"].
MUST BE ORDERED SEPARATELY
3. THE MATING CONNECTOR FOR THIS APPLICATION MUST USE A
WALL-LESS HEADER HOUSING, P/N 63735-101, TO AVOID
INTERFERENCE WITH MOUNTING SCREW HEADS.

REQUIRED PC BOARD LAYOUT
COMPONENT SIDE

4. PART NUMBER WITH "LF" SUFFIX AT THE END ARE LEAD FREE OPTION
5. THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATION AS DESCRIBED IN GS-22-008.
6. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 15 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.5mm MINIMUM THICK CIRCUIT BOARD OR FOR 10-20 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN. SEE APPLICATION NOTES/PROCEDURES IF THEY ARE AVAILABLE.

[illegible]

PRODUCT #	DESCRIPTION
88917-401 & -401LF	CLAW RETENTION VERSION



NOTES:

- HOUSING MATERIAL: LCP, 30% GLASS FILLED
FLAME RETARDANT PER UL 94V-0.
COLOR: NATURAL
- INDICATED HOLES ARE UNPLATED.

- PART NUMBER WITH "LF" SUFFIX AT THE END ARE LEAD FREE OPTION
- THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATION AS DESCRIBED IN GS-22-008.
- THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 15 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.5mm MINIMUM THICK CIRCUIT BOARD OR FOR 10-20 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN. SEE APPLICATION NOTES/PROCEDURES IF THEY ARE AVAILABLE.

mat'l. code SEE NOTES				surface ISO 1302 ✓	tolerance ISO 406 ISO 1101	projection mm	product family METRAL ACC.
ltr	ecn	no	dr	date	tolerances unless otherwise specified		title
M					angles linear	mm	RECEPTACLE GUIDE MODULE, 4 ROW
					0°±2'	scale 1:1	
			dr	S. STONER	9/30/93	FCI	dwg no
			enr	R. DOUTRICH	9/30/93		sheet 4 of 4
			chr	S. STONER	9/30/93		size
			appd	S. STONER	9/30/93		A3
sheet	revision						type
index	sheet						Product Customer Drawing

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

FCI:

[88917-201](#) [88917-101](#) [88917-201LF](#) [88917-301LF](#) [88917-101LF](#) [88917-301](#)